

RESTRICTED AREA
(No pattern and via hole.)

Card misinsertion position.
(No components allowed in this area.)

All patterns and Via holes under the connector should be coated by resist.

APPLICABLE P.W.B. DIMENSION(REF.)

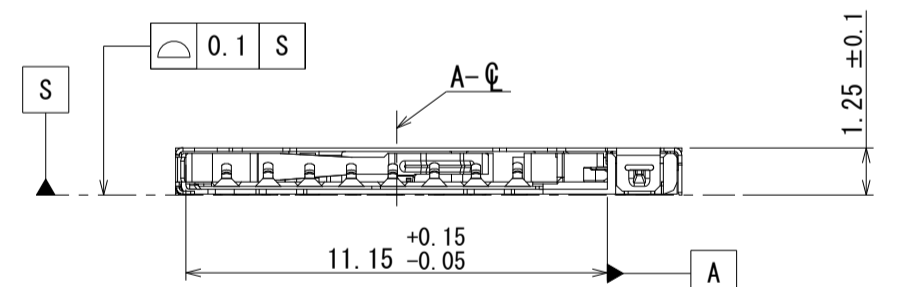
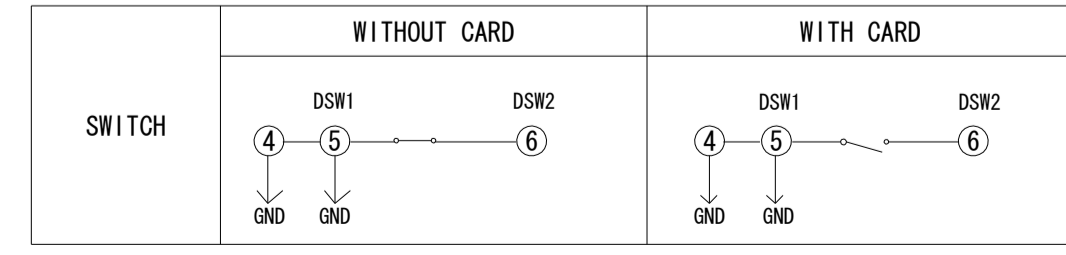


TABLE2. FINISH

	CONTACT AREA	TERMINAL AREA
① CONTACT	Au (0.5 μm MIN) OVER Ni (2 μm MIN)	Au FLASH (0.03 μm MIN) OVER Ni (1 μm MIN)
⑤ DETECTION SWITCH 1(DSW1) ⑥ DETECTION SWITCH 2(DSW2)	Au (0.1 μm MIN) OVER Ni (1 μm MIN)	
④ TOP COVER	-	Au FLASH (0.03 μm MIN)

TABLE1. CIRCUIT



符号 No.	名称 DESCRIPTION	数量 QTY.	材料 MATERIAL	仕上 FINISH	備考 REMARKS
9	SPRING	1	STAINLESS	-	-
8	CAM FOLLOWER	1	STAINLESS	-	-
7	LOCK	1	STAINLESS	-	-
6	DETECTION SWITCH 2(DSW2)	1	COPPER ALLOY	TABLE2	TABLE1
5	DETECTION SWITCH 1(DSW1)	1	COPPER ALLOY	TABLE2	TABLE1
4	TOP COVER	1	STAINLESS	TABLE2	-
3	EJECT LEVER	1	GLASS FILLED Ny	-	-
2	INSULATOR	1	GLASS FILLED LCP	-	-
1	CONTACT	8	COPPER ALLOY	TABLE2	-

仕様書(SPECIFICATION)		第1版(ORIGINAL DATE) 14/FEB/2013	尺度(SCALE) 5:1	シリーズ(SERIES) ST11	日本航空電子工業株式会社
製図 DR.		担当 CHK.	名称(TITLE) ST11S008V4H		JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.
一般公差(GENERAL TOLERANCE)		製図 CHK.	質量(MASS)		
寸法(DIMENSION)	角度(ANGLES)	査閲 APPD.	単位(UNIT): mm		図面番号(DRAWING NO.) SJ113824
±0.8	° ±	承認 APPD.	品質(MASS)		版数(VER.) 1
× ±0.4	×° ±	承認 APPD.	品質(MASS)		
×× ±0.1	××° ±		品質(MASS)		
××× ±	×××° ±		品質(MASS)		